

CUBE Inline⁺

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The modular Soldering System for highest efficiency

CUBE Inline⁺ The modular soldering system



Clearly structured control

The simple, graphical programming allows a quick entry into the selective soldering. At the same time, the facility provides professional functions, such as process monitoring, DC-servomotors with bus connection.

Precise flux control

The drop jet fluxer is the perfect solution for flux application. Depending on the cycle time requirement, the system can be equipped with multiple spray heads. Optical monitoring of flux deposition

via a light beam is standard on all INERTEC selective soldering systems, as an option we can also offer a flux flow monitoring system that will accurately measure the volume of flux being applied to each board.



The intelligent modular system, flexible for every kind of customer requirements. The best possible construction of all components of the system ensures a maintenance-friendly accessibility.









High efficiency preheating

Depending on the system specification , the number of preheating modules as well as the preheating type can be selected as desired.

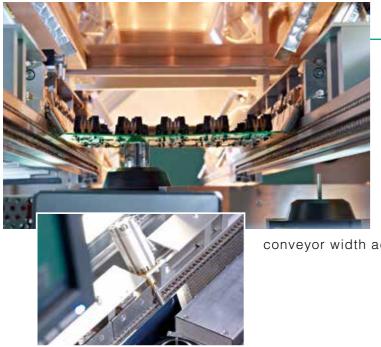
The quartz preheating - which is the standard - provides efficient preheating with low energy consumption.

The PCB temperature can be controlled via an optional pyrometer and the values transferred in BDE data.

Process control & monitoring

Perfect process control is ensured by options such as a process camera, electronic monitoring of the soldering wave height, position correction by fiducial detection and bending of the PCB by a warpage control sensor.





Robust conveyor

The segmented conveyor in the system is equipped with a pin chain.

The workpiece carrier or the PCB is placed precisely at the individual process positions through a stopper system. The system can be ordered with an automatic

conveyor width adjustment as an option.

Quick solder exchange

A quick change-over of the solder pot to enable the use of different solders is possible through a special trolley.









Mini wave soldering module

The option nitrogen preheating of the perfectly designed solder nozzles enables the continuous heating of the joint during the soldering process and heats the immediate soldering area evenly.

The integration of two soldering units in the system offers the possibility to work with two different alloys or with different nozzle sizes.

ActiveFlow soldering module

ActiveFlow allows a high energy transfer between the smallest component clearances for PCB up to dimensions of 400 x 400 mm. Through the construction of the system, short cycle times of 30 seconds aren't a challenge for INERTEC.

Simple tool change

The active flow module is maintenance friendly and can be driven out of the system by means of a motor either for maintenance or tool change over. The tool mount developed especially by INERTEC guarantees a quick and accurate - correct tool exchange.

The soldering height is actively controlled and ensures together with the nitrogen supply a perfect soldering result.



All components are coated. The stamps are made of titanium and therefore will not wear out or degrade like stainless steel stamps.

The circulation of the solder within the ActiveFlow creates a perfect soldering result caused by a targeted energy input, surrounding SMD components are not overheated.



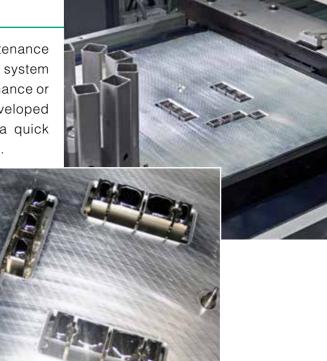
Changeable solder nozzles

The advanced design of the nozzles allows a quick exchange. If products with a different nozzle size have to be soldered, the insert of the nozzle is simply changed to the appropriate nozzle diameter.









CUBE Inline⁺ The modular soldering system



The INERTEC CUBE Inline⁺ modular system offers a modular system with all the required process stages according to customer specification.



From the basic design to the production line

The clever design of the modules makes retrofitting modules at a later date possible and of course back again. As required.

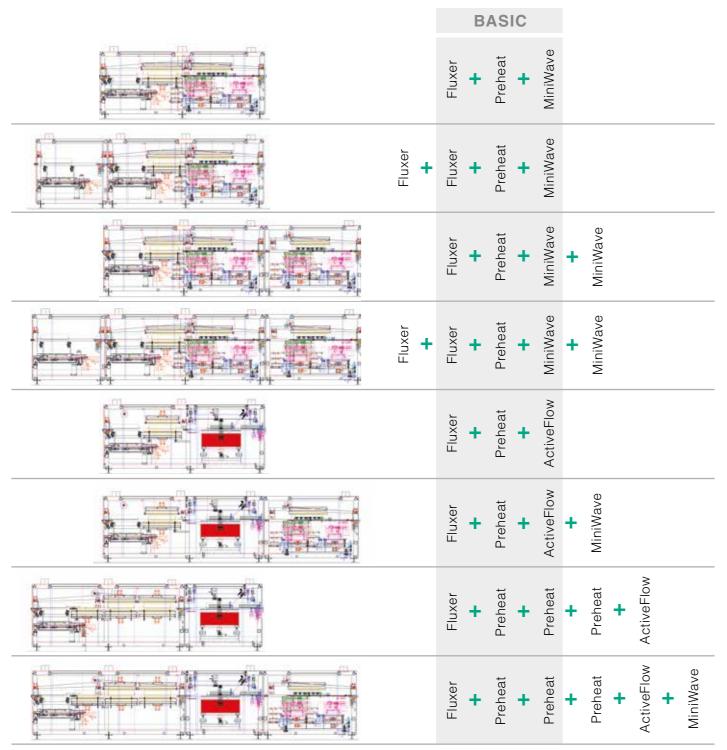




CUBE Inline⁺ Equipped for all tasks

Versatile system expansions are possible

Whether the CUBE Inline⁺ is used as a base system or with one of the many options, with the CUBE Inline⁺ you are prepared for all challenges.



Intuitive control software

The control for the CUBE Inline⁺ is based on a BECKHOFF PLC. It is modular, so retrofits are possible and easily implemented at the customers site.

For programming, INERTEC uses a graphical interface via the convenient offline software or online programming via the built-in camera. Software modules, such as PCB-warpage-correction or the optional Fiducial module, detect and correct the circuit board position during the soldering process.

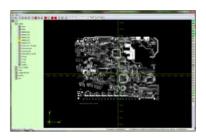
Industry 4.0 - The control offers all possibilities of data acquisition via XML tickets, via TCPIP, as an ASCII file of an SQL database or an ITAC connection.

During the process, statistics modules capture all relevant PCB data by the DMX code or program name.

A line recorder function allows the analog measured values (such as solder temperature or nitrogen temperature) to be recorded. Barcode integration, automatic time functions, integrated service messages, as well as online access are standard functions and already included in the software.













Technical Configurations

Pallet	Pin Chain Conveyor, 5 mm	
	Pin Chain Conveyor, 3 mm	
РСВ	Pin Chain Conveyor, 5 mm	
	Pin Chain Conveyor, 3 mm	
	Manual width adjustment - handwheel	
	Automatic width adjustment	
	Dual Conveyor - on request	

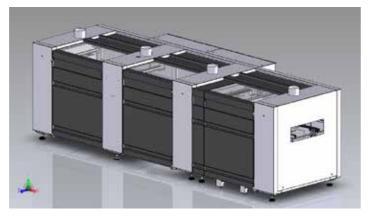
Inlet Conveyor	Supplied by customer	
	INERTEC can supply on customers specification	
Outlet Conveyor	Supplied by customer	
	INERTEC can supply on customers specification	

Return Conveyor	ActiveFlow	
	Mini wave - depending on the inlet height	
Interface	SMEMA	
	SV70	
	Special Solutions	

Fluxer	Micro Drop Jet Fluxer < 5 % solids	
	Dual Spray Head - fix width	
	Automatic width setting crosswise/ lengthwise	
	SONOTEC Fluxer - use for higher solids	
	Automatic Flux Nozzle Cleaning	
	3 I pressurized container	
	Second flux container - various flux usage -only in cobination with a separate spray head	
	Optical Spray Control via Lasersensor - only drop jet	
	Flux Volume Control - Flow Sensor	
	Indexation during fluxing via stopper	
	Indexation during fluxing via cylinder	
	Fiducial Correction (need to be defined)	

Preheat Area	1 preheat zone	
	2 preheat zones	
	3 preheat zones	
	Convection heater	
	Air Flow Control	
	IR heater	
	Quick reacting quartz heater	
	Power management	
	Combination of heaters	
	Pyrometer control for the quartz heater	

Top Side Heat	1 preheat zone	
	several preheat zones - max. 4 zones in the fully equipped system	
	Convection heater	
	Air Flow Control	
	IR heater	
	Quick reacting quartz heater	
	Power management	
	Combination of heaters	





Solder Area	One soldering module	
Mini Wave	Second Soldering Module	
	Fixed width - 140 mm	
	Automatic width adjustment to 340 mm	
	Coated Solder Aggregate - Titanium Pumps	
	Solder level control	
	Automatic level - solder feeder	
	Multiport Tool - up to 5 parallel nozzles (max. 200mm distance)	
	Process Camera	
	Positioning - Clamping - 3 mm height	
	Fiducial Correction	
	Warpage Correction	
	Nitrogen Flow Control	
	Hot Nitrogen Feature	
	Automatic Wave Height Measurement	
	Special Board Support	
	Automatic Nozzle Cleaning	
	Tool Coding - BCD coding	
	Tool Coding - RFID coding	
	Exchangeable soldering unit - different alloy	
	Trolley	

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Second Soldering Module	
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	Second Soldering Module Fixed width - 140 mm Automatic width adjustment to 340 mm Coated Solder Aggregate - Titanium Pumps Solder level control Automatic level - solder feeder Multiport Tool - up to 5 parallel nozzles (max. 200mm distance) Process Camera Positioning - Clamping - 3 mm height Fiducial Correction Warpage Correction Nitrogen Flow Control Hot Nitrogen Feature Automatic Nozzle Cleaning Tool Coding - BCD coding Tool Coding - RFID coding Exchangeable soldering unit - different alloy

Technical Configuration of Solder Areas

Solder Area	Coated Solder Aggregate - 400 x 400 mm	
ActiveFlow	Second Soldering Module	
	Coated Solder Aggregate	
	Solder level control	
	Automatic level - solder feeder	
	Positioning - Clamping	
	Automatic Wave Height Measurement	
	Tooling - based on customer STEP Data	
	Down Holder Function	
	Nitrogen Flow Control	
	Special Board Support	
	Tool Coding - BCD coding	
	Tool Coding - RFID coding	
	Nitrogen volume control	
	Top Side heat	X

Solder Area	Coated Solder Aggregate - 400 x 400 mm	
ActiveFlow	Second Soldering Module	
Expansion Module	Coated Solder Aggregate	
	Solder level control	
	Automatic level - solder feeder	
	Positioning - Clamping	
	Automatic Wave Height Measurement	
	Tooling - based on customer STEP Data	
	Down Holder Function	
	Nitrogen Flow Control	
	Special Board Support	
	Tool Coding - BCD coding	
	Tool Coding - RFID coding	
	Nitrogen volume control	
	Top Side heat	x





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